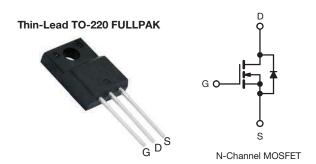
Vishay Siliconix

COMPLIANT HALOGEN

FREE

EL Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.105			
Q _g max. (nC)	120				
Q _{gs} (nC)	14				
Q _{gd} (nC)	19				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA30N60AEL-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V_{DS}	600	.,		
Gate-source voltage			V_{GS}	± 30	V		
Continuous drain current (T _J = 150 °C) e	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	28	A		
		T _C = 100 °C		18			
Pulsed drain current ^a			I _{DM}	68			
Linear derating factor			0.3	W/°C			
Single pulse avalanche energy b			E _{AS}	353	mJ		
Maximum power dissipation			P _D	39	W		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C			
Reverse diode dv/dt ^d		dv/dt	32	V/ns			
Soldering recommendations (peak temperature) c	For 10 s			260	°C		
Mounting torque	M3 screw			0.6	Nm		

Notes

- Initial samples marked as SiHA30N60BE
- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W		
Maximum junction-to-case (drain)	R_{thJC}	-	3.2	C/VV		

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static		•					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	_	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.68	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	4.0	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
		V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A	-	0.105	0.120	Ω
Forward transconductance	9 _{fs}	V _{DS} = 20 V, I _D = 15 A		-	19	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	2565	-	pF
Output capacitance	C _{oss}			-	109	-	
Reverse transfer capacitance	C _{rss}			-	6	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	71	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	367	-	
Total gate charge	Qg			-	60	120	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 15 \text{ A}, V_{DS} = 480 \text{ V}$		14	-	nC
Gate-drain charge	Q _{gd}	7			19	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 15 A,		-	26	52	
Rise time	t _r			-	24	48	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		79	158	- ns -
Fall time	t _f				33	66	
Gate input resistance	R_g	f = 1 MHz, open drain		0.35	0.72	1.45	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	26	
Pulsed diode forward current	I _{SM}			-	-	68	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	T _J = 25 °C, I _F = I _S = 15 A, di/dt = 100 A/µs, V _R = 400 V		-	335	670	ns
Reverse recovery charge	Q _{rr}			-	5.4	10.8	μC
Reverse recovery current	I _{RRM}			_	30	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

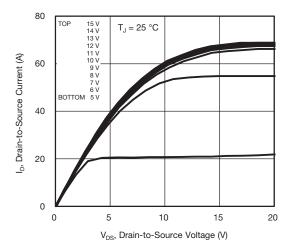


Fig. 1 - Typical Output Characteristics

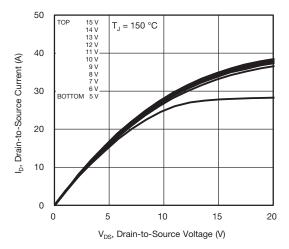


Fig. 2 - Typical Output Characteristics

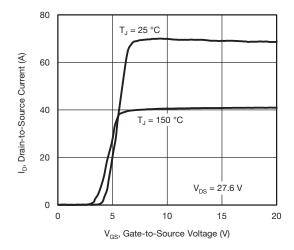


Fig. 3 - Typical Transfer Characteristics

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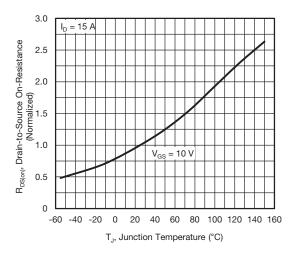


Fig. 4 - Normalized On-Resistance vs. Temperature

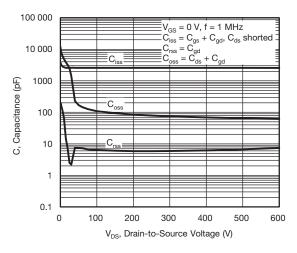


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

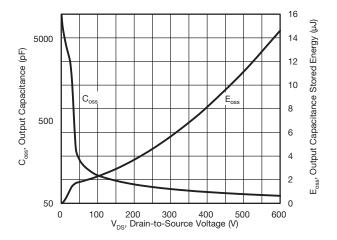


Fig. 6 - Coss and Eoss vs. VDS



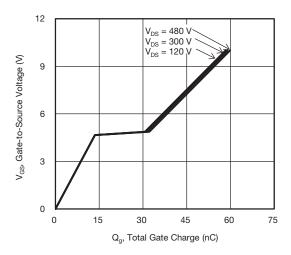


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

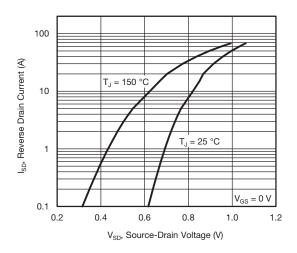


Fig. 8 - Typical Source-Drain Diode Forward Voltage

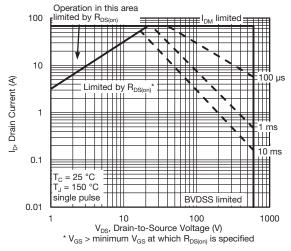


Fig. 9 - Maximum Safe Operating Area

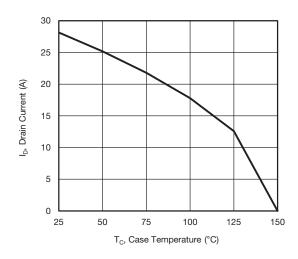


Fig. 10 - Maximum Drain Current vs. Case Temperature

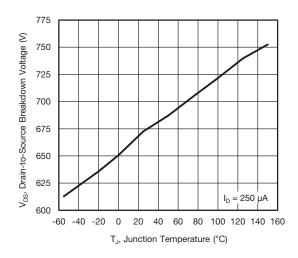


Fig. 11 - Temperature vs. Drain-to-Source Voltage



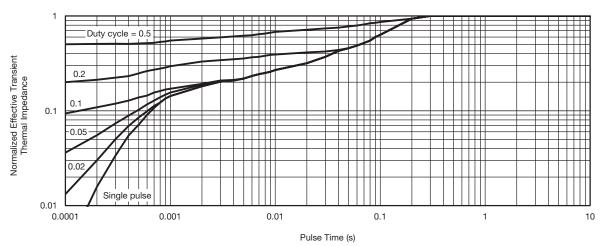


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

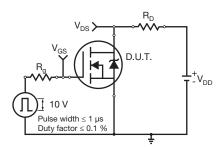


Fig. 13 - Switching Time Test Circuit

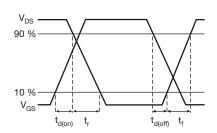


Fig. 14 - Switching Time Waveforms

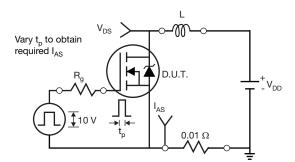


Fig. 15 - Unclamped Inductive Test Circuit

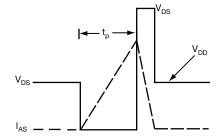


Fig. 16 - Unclamped Inductive Waveforms

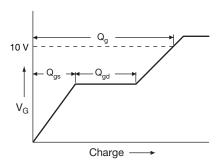


Fig. 17 - Basic Gate Charge Waveform

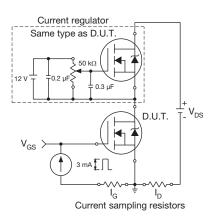
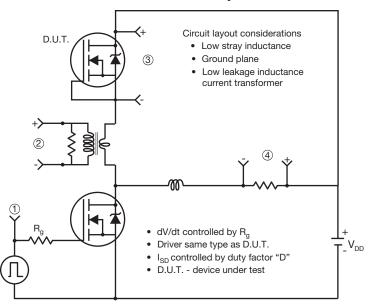


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



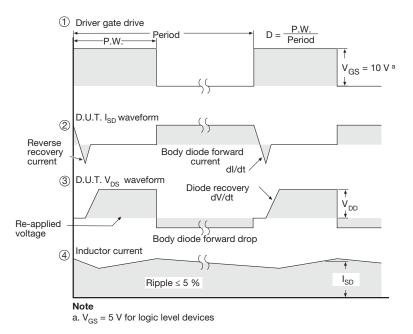


Fig. 19 - For N-Channel

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